

1. Description

1.1. Project

Project Name	tdse-tp0_05-hw_sw_test_
Board Name	NUCLEO-F103RB
Generated with:	STM32CubeMX 6.12.0
Date	08/27/2024

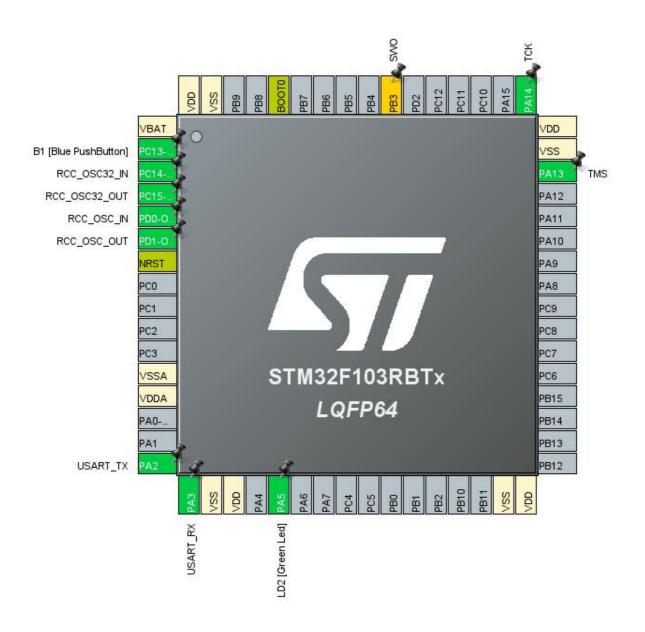
1.2. MCU

MCU Series	STM32F1
MCU Line	STM32F103
MCU name	STM32F103RBTx
MCU Package	LQFP64
MCU Pin number	64

1.3. Core(s) information

Core(s)	Arm Cortex-M3

2. Pinout Configuration



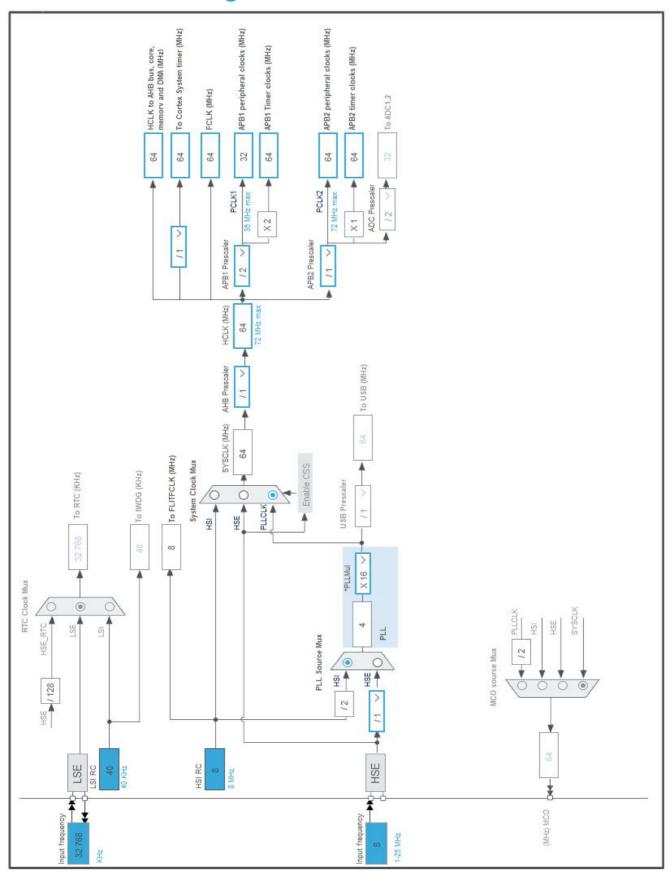
3. Pins Configuration

Pin Number LQFP64	Pin Name (function after reset)	Pin Type	Alternate Function(s)	Label
1	VBAT	Power		
2	PC13-TAMPER-RTC	I/O	GPIO_EXTI13	B1 [Blue PushButton]
3	PC14-OSC32_IN	I/O	RCC_OSC32_IN	
4	PC15-OSC32_OUT	I/O	RCC_OSC32_OUT	
5	PD0-OSC_IN	I/O	RCC_OSC_IN	
6	PD1-OSC_OUT	I/O	RCC_OSC_OUT	
7	NRST	Reset		
12	VSSA	Power		
13	VDDA	Power		
16	PA2	I/O	USART2_TX	USART_TX
17	PA3	I/O	USART2_RX	USART_RX
18	VSS	Power		
19	VDD	Power		
21	PA5 *	I/O	GPIO_Output	LD2 [Green Led]
31	VSS	Power		
32	VDD	Power		
46	PA13	I/O	SYS_JTMS-SWDIO	TMS
47	VSS	Power		
48	VDD	Power		
49	PA14	I/O	SYS_JTCK-SWCLK	TCK
55	PB3 **	I/O	SYS_JTDO-TRACESWO	SWO
60	воото	Boot		
63	VSS	Power		
64	VDD	Power		

^{*} The pin is affected with an I/O function

^{**} The pin is affected with a peripheral function but no peripheral mode is activated

4. Clock Tree Configuration



1. Power Consumption Calculator report

1.1. Microcontroller Selection

Series	STM32F1
Line	STM32F103
MCU	STM32F103RBTx
Datasheet	DS5319_Rev17

1.2. Parameter Selection

Temperature	25
Vdd	3.3

1.3. Battery Selection

Battery	Li-SOCL2(A3400)
Capacity	3400.0 mAh
Self Discharge	0.08 %/month
Nominal Voltage	3.6 V
Max Cont Current	100.0 mA
Max Pulse Current	200.0 mA
Cells in series	1
Cells in parallel	1

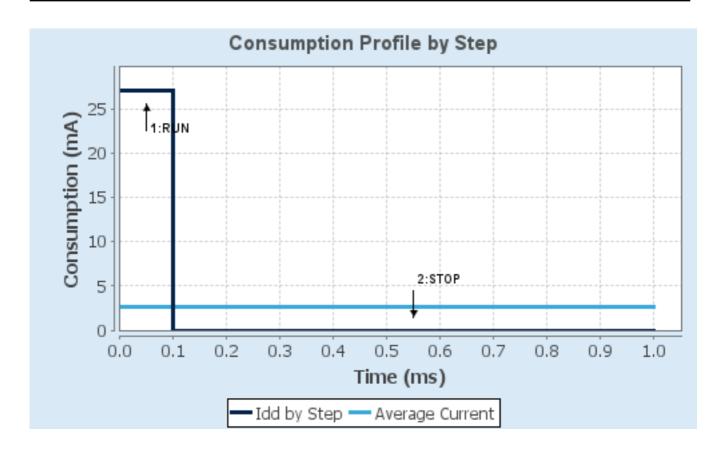
1.4. Sequence

Step	Step1	Step2
Mode	RUN	STOP
Vdd	3.3	3.3
Voltage Source	Battery	Battery
Range	No Scale	No Scale
Fetch Type	FLASH	n/a
CPU Frequency	72 MHz	0 Hz
Clock Configuration	HSE PLL	Regulator LP
Clock Source Frequency	8 MHz	0 Hz
Peripherals		
Additional Cons.	0 mA	0 mA
Average Current	27 mA	14 μΑ
Duration	0.1 ms	0.9 ms
DMIPS	90.0	0.0
Та Мах	100.99	105
Category	In DS Table	In DS Table

1.5. Results

Sequence Time	1 ms	Average Current	2.71 mA
Battery Life	1 month, 21 days,	Average DMIPS	61.0 DMIPS
	17 hours		

1.6. Chart



2. Software Project

2.1. Project Settings

Name	Value
Project Name	tdse-tp0_05-hw_sw_test_
Project Folder	C:\Users\lauta\STM32CubelDE\workspace_1.16.0\tdse-tp0_05-hw_sw_test_
Toolchain / IDE	STM32CubeIDE
Firmware Package Name and Version	STM32Cube FW_F1 V1.8.6
Application Structure	Advanced
Generate Under Root	Yes
Do not generate the main()	No
Minimum Heap Size	0x200
Minimum Stack Size	0x400

2.2. Code Generation Settings

Name	Value
STM32Cube MCU packages and embedded software	Copy only the necessary library files
Generate peripheral initialization as a pair of '.c/.h' files	No
Backup previously generated files when re-generating	No
Keep User Code when re-generating	Yes
Delete previously generated files when not re-generated	Yes
Set all free pins as analog (to optimize the power	No
consumption)	
Enable Full Assert	No

2.3. Advanced Settings - Generated Function Calls

Rank	Function Name	Peripheral Instance Name
1 SystemClock_Config		RCC
2 MX_GPIO_Init		GPIO
3 MX_USART2_UART_Init		USART2

3. Peripherals and Middlewares Configuration

3.1. RCC

High Speed Clock (HSE): BYPASS Clock Source

Low Speed Clock (LSE): Crystal/Ceramic Resonator

3.1.1. Parameter Settings:

System Parameters:

VDD voltage (V) 3.3
Prefetch Buffer Enabled

Flash Latency(WS) 2 WS (3 CPU cycle)

RCC Parameters:

HSI Calibration Value 16
HSE Startup Timout Value (ms) 100
LSE Startup Timout Value (ms) 5000

3.2. SYS

Debug: Serial Wire

Timebase Source: SysTick

3.3. **USART2**

Mode: Asynchronous

3.3.1. Parameter Settings:

Basic Parameters:

Baud Rate 115200

Word Length 8 Bits (including Parity)

Parity None Stop Bits 1

Advanced Parameters:

Data Direction Receive and Transmit

Over Sampling 16 Samples

^{*} User modified value

4. System Configuration

4.1. GPIO configuration

IP	Pin	Signal	GPIO mode	GPIO pull/up pull down	Max Speed	User Label
RCC	PC14- OSC32_IN	RCC_OSC32_IN	n/a	n/a	n/a	
	PC15- OSC32_OU T	RCC_OSC32_O UT	n/a	n/a	n/a	
	PD0- OSC_IN	RCC_OSC_IN	n/a	n/a	n/a	
	PD1- OSC_OUT	RCC_OSC_OUT	n/a	n/a	n/a	
SYS	PA13	SYS_JTMS- SWDIO	n/a	n/a	n/a	TMS
	PA14	SYS_JTCK- SWCLK	n/a	n/a	n/a	TCK
USART2	PA2	USART2_TX	Alternate Function Push Pull	n/a	Low	USART_TX
	PA3	USART2_RX	*	No pull-up and no pull-down	n/a	USART_RX
Single Mapped Signals	PB3	SYS_JTDO- TRACESWO	n/a	n/a	n/a	SWO
GPIO	PC13- TAMPER- RTC	GPIO_EXTI13	External Interrupt Mode with Rising edge trigger detection	No pull-up and no pull-down	n/a	B1 [Blue PushButton]
	PA5	GPIO_Output	Output Push Pull	No pull-up and no pull-down	Low	LD2 [Green Led]

4.2. DMA configuration

nothing configured in DMA service

4.3. NVIC configuration

4.3.1. NVIC

Interrupt Table	Enable	Preenmption Priority	SubPriority	
Non maskable interrupt	true	0	0	
Hard fault interrupt	true	0	0	
Memory management fault	true	0	0	
Prefetch fault, memory access fault	true	0	0	
Undefined instruction or illegal state	true	0	0	
System service call via SWI instruction	true	0	0	
Debug monitor	true	0	0	
Pendable request for system service	true	0	0	
System tick timer	true	0	0	
EXTI line[15:10] interrupts	true	0	0	
PVD interrupt through EXTI line 16	unused			
Flash global interrupt	unused			
RCC global interrupt	unused			
USART2 global interrupt	unused			

4.3.2. NVIC Code generation

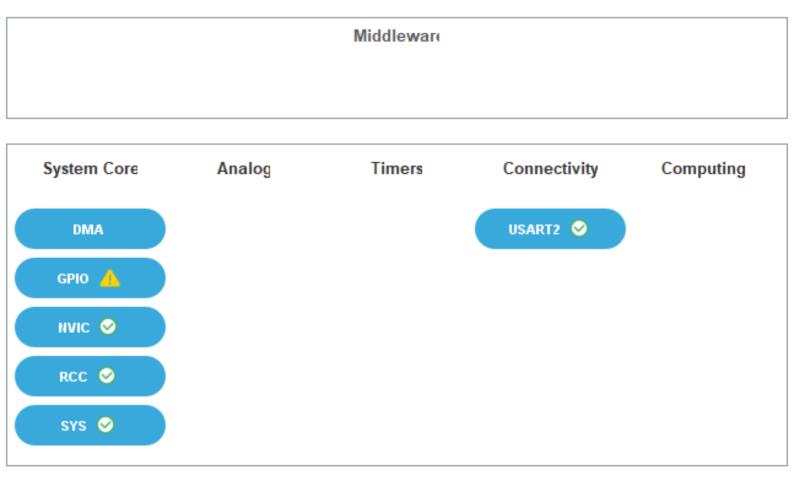
Enabled interrupt Table	Select for init sequence ordering	Generate IRQ handler	Call HAL handler
Non maskable interrupt	false	true	false
Hard fault interrupt	false	true	false
Memory management fault	false	true	false
Prefetch fault, memory access fault	false	true	false
Undefined instruction or illegal state	false	true	false
System service call via SWI instruction	false	true	false
Debug monitor	false	true	false
Pendable request for system service	false	true	false
System tick timer	false	true	true
EXTI line[15:10] interrupts	false	true	true

* User modified value

5. System Views

5.1. Category view

5.1.1. Current



6. Docs & Resources

Type Link